

1H, 2022 Investor Conference

尼得科超眾科技股份有限公司 Nidec Chaun-Choung Technology Corp.

Date: Aug. 31st, 2022

Nidec Chaun-Choung Technology Corporation



Disclaimer

This presentation of NCCI contains forward-looking statements subject to risks and uncertainties. Actual results may differ materially from the contained in the forward-looking statements.

The forward-looking statements in this presentation are the current belief of NCCI as of the date for this release, and NCCI has no obligation to update the forward-looking statements for new information, future events, or otherwise.





- Company Profile
- 1H, 2022 Financial Results
- Focus: Market, Products & Technologies
- Q&A

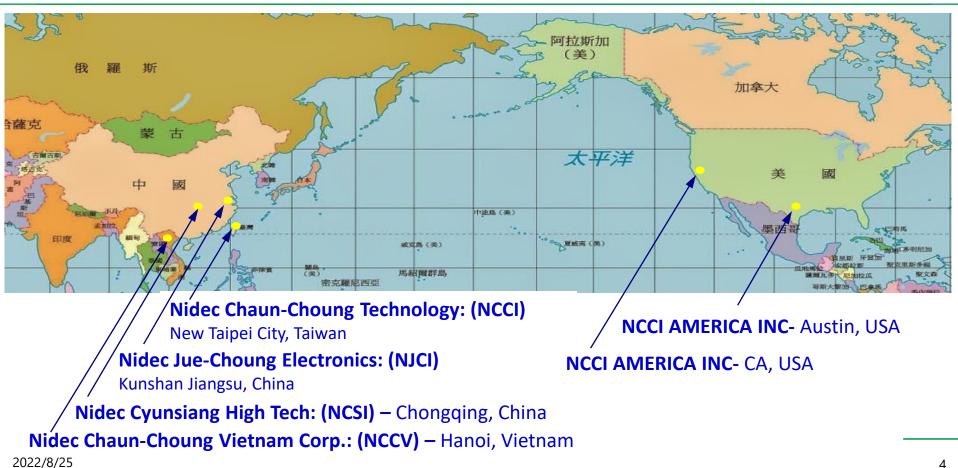
Company Profile



- New Company Name: <u>Nidec Chaun-Choung Technology Corp.</u> (Since Jan. 2021)
- Founded : <u>Dec.14. 1973</u>
- Nidec: Hold 86.23% shares, as a major shareholder (Jul. 2022).
- Address : No. 184-3, Zhongxing N. St., Sanchong Dist., New Taipei City 241, Taiwan
- **Capital :** <u>NT\$ 863,434 (K)</u>
- Main Business : <u>Heat Sink & Thermal Solutions</u>
- WW Factories & Offices

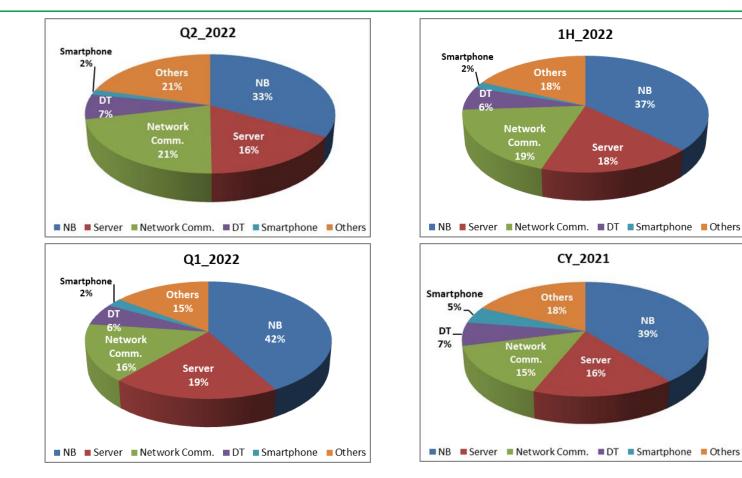
WW Factories & Offices





Product Mix

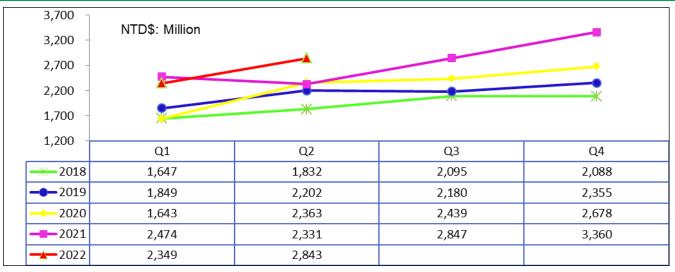


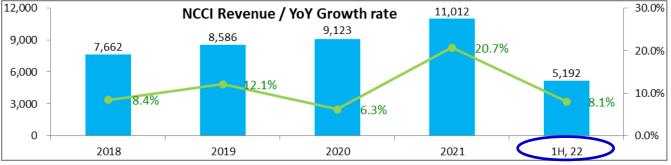


2022/8/25

Revenue



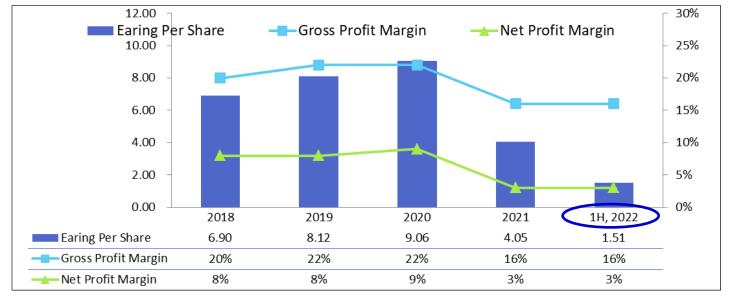




NTD\$: Million

Financial Index I.





Years Items	2018	2019	2020	2021	1H, 2022
Earing Per Share	6.90	8.12	9.06	4.05	1.51
Gross Profit Margin	20%	22%	22%	16%	16%
Net Profit Margin	8%	8%	9%	3%	3%

Financial Index II

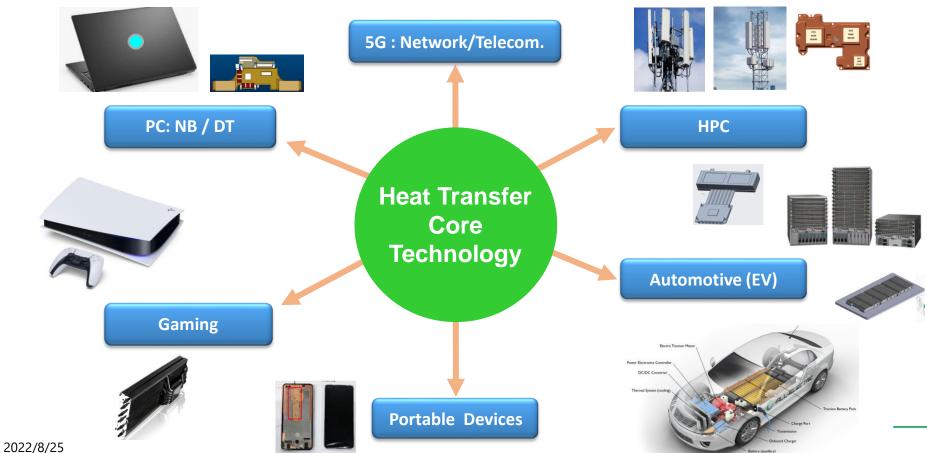


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200% 180% - 160% - 140% - 120% - 100% - 80% - 60% - 40% - 20% 0%					
Debt Ratio	2018	2019	2020	2021	1H, 2022
	44%	44%	49%	56%	54%
Current Ratio	197%	197%	177%	173%	182%
Quick Ratio	154%	160%	141%	130%	123%
Years Items	2018	2019	2020	2021	1H, 2022
Debt Ratio	44%	44%	49%	56%	54%
Current Ratio	197%	197%	177%	173%	b 182%
Quick Ratio	154%	160%	141%	130%	b 123%

Focus Market

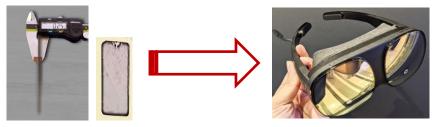




Focus Thermal Solution – I.



- VR Glasses Thermal Solution Metaverse
 - 5W, Ultra Thin & Light VC (0.25~0.30mm) Heat Spreader



- Power Sensor Thermal Solution AIO / Laser Imaging Detection Ranging
 - 500W, 3D-VC / HP Thermal Module





Focus Thermal Solution – II.



- Telecom. Thermal Solution High Performance Computing
 - 1KW, VC / HP Thermal Module





IGBT (Insulated Gate Bipolar Transistor) Thermal Solution - Electric Vehicle
 - 45KW, Cold Plate



Competitive Advantages - I

- Metallurgy & Hybrid Wick Technology –Nidec & NCCI team with strong basic research andProprietary multi-wick design to support Ultra-thin / Hi-power Thermal Solutions.
- Automation Equipment Building in House –
 Nidec & NCCI team up to develop manufacturing machine from sample to mass production, and know-how in house.
- Active & Passive Horizontal Division of Collaborating –

Nidec is good at Fan/Pump active solution and NCCI is good at HP/VC passive solution, collaboration to provide customer total solution with best options.









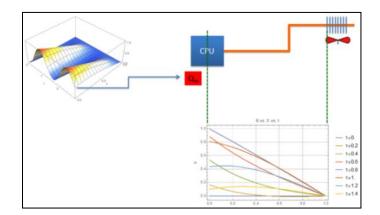
Competitive Advantages - II



• Active Thermal Module Fan Cooling Control Technology –

Nidec & NCCI Apply high thermal capability design on to Fan speed control with cooling algorithm to meet advance chip turbo boosting thermal jump demanding.







Q & A

